

SQJ858EP-T1_GE3 Datasheet



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DiGi Electronics Part Number	SQJ858EP-T1_GE3-DG
Manufacturer	Vishay Siliconix
Manufacturer Product Number	SQJ858EP-T1_GE3
Description	MOSFET N-CH 40V 75A PPAK SO-8
Detailed Description	N-Channel 40 V 75A (Tc) 68W (Tc) Surface Mount PowerPAK® SO-8



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Purchase and inquiry

Manufacturer Product Number:

SQJ858EP-T1_GE3

Series:

TrenchFET®

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

40 V

Drive Voltage (Max Rds On, Min Rds On):

4.5V, 10V

Vgs(th) (Max) @ Id:

2.5V @ 250µA

Vgs (Max):

±20V

FET Feature:

-

Operating Temperature:

-55°C ~ 175°C (Tj)

Qualification:

AEC-Q101

Supplier Device Package:

PowerPAK® SO-8

Base Product Number:

SQJ858

Manufacturer:

Vishay Siliconix

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

75A (Tc)

Rds On (Max) @ Id, Vgs:

6mOhm @ 11A, 10V

Gate Charge (Qg) (Max) @ Vgs:

60 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

2500 pF @ 20 V

Power Dissipation (Max):

68W (Tc)

Grade:

Automotive

Mounting Type:

Surface Mount

Package / Case:

PowerPAK® SO-8

Environmental & Export classification

Moisture Sensitivity Level (MSL):

1 (Unlimited)

HTSUS:

8541.29.0095

ECCN:

EAR99



Automotive N-Channel 40 V (D-S) 175 °C MOSFET



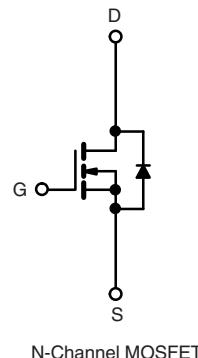
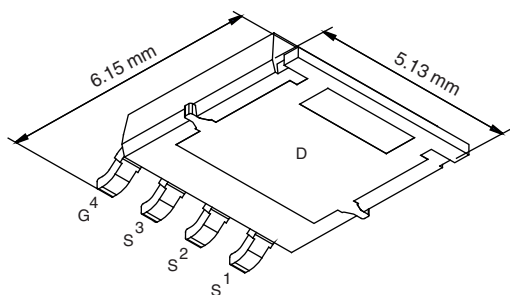
PRODUCT SUMMARY

V_{DS} (V)	40
$R_{DS(on)}$ (Ω) at $V_{GS} = 10$ V	0.006
$R_{DS(on)}$ (Ω) at $V_{GS} = 4.5$ V	0.009
I_D (A)	75
Configuration	Single

FEATURES

- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- AEC-Q101 Qualified
- Material categorization:
For definitions of compliance please see www.vishay.com/doc?99912

PowerPAK® SO-8L Single



ORDERING INFORMATION

Package	PowerPAK SO-8L
Lead (Pb)-free and Halogen-free	SQJ858EP-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	$T_C = 25$ °C	75
		$T_C = 125$ °C	43
Continuous Source Current (Diode Conduction)	I_S	60	A
Pulsed Drain Current ^a	I_{DM}	200	
Single Pulse Avalanche Current	$L = 0.1$ mH	I_{AS}	40
Single Pulse Avalanche Energy		E_{AS}	80
Maximum Power Dissipation ^a	P_D	$T_C = 25$ °C	68
		$T_C = 125$ °C	22
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 175	°C
Soldering Recommendations (Peak Temperature) ^{c, d}		260	

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient	R_{thJA}	68	°C/W
Junction-to-Case (Drain)			

Notes

- Pulse test; pulse width ≤ 300 μ s, duty cycle ≤ 2 %.
- When mounted on 1" square PCB (FR-4 material).
- See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0, I_D = 250\text{ }\mu\text{A}$		40	-	-	V
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$		1.5	2.0	2.5	
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$		-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 40\text{ V}$	-	-	1	μA
		$V_{GS} = 0\text{ V}$	$V_{DS} = 40\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	-	50	
		$V_{GS} = 0\text{ V}$	$V_{DS} = 40\text{ V}, T_J = 175\text{ }^\circ\text{C}$	-	-	150	
On-State Drain Current ^a	$I_{D(on)}$	$V_{GS} = 10\text{ V}$	$V_{DS} \geq 5\text{ V}$	30	-	-	A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 10\text{ V}$	$I_D = 11\text{ A}$	-	0.005	0.006	Ω
		$V_{GS} = 4.5\text{ V}$	$I_D = 9\text{ A}$	-	0.007	0.009	
		$V_{GS} = 10\text{ V}$	$I_D = 11\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	-	0.015	
		$V_{GS} = 10\text{ V}$	$I_D = 11\text{ A}, T_J = 175\text{ }^\circ\text{C}$	-	-	0.019	
Forward Transconductance ^b	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 11\text{ A}$		-	49	-	S
Dynamic^b							
Input Capacitance	C_{iss}	$V_{GS} = 0\text{ V}$	$V_{DS} = 20\text{ V}, f = 1\text{ MHz}$	-	2000	2500	μF
Output Capacitance	C_{oss}			-	500	625	
Reverse Transfer Capacitance	C_{riss}			-	220	275	
Total Gate Charge ^c	Q_g	$V_{GS} = 10\text{ V}$	$V_{DS} = 20\text{ V}, I_D = 16\text{ A}$	-	39	60	nC
Gate-Source Charge ^c	Q_{gs}			-	6.7	-	
Gate-Drain Charge ^c	Q_{gd}			-	8	-	
Gate Resistance	R_g	f = 1 MHz		0.40	0.83	1.30	Ω
Turn-On Delay Time ^c	$t_{d(on)}$	$V_{DD} = 20\text{ V}, R_L = 20\text{ }\Omega$ $I_D \cong 1\text{ A}, V_{GEN} = 10\text{ V}, R_g = 6\text{ }\Omega$		-	18	27	ns
Rise Time ^c	t_r			-	10	15	
Turn-Off Delay Time ^c	$t_{d(off)}$			-	38	57	
Fall Time ^c	t_f			-	17	26	
Source-Drain Diode Ratings and Characteristics^b							
Pulsed Current ^a	I_{SM}			-	-	200	A
Forward Voltage	V_{SD}	$I_F = 10\text{ A}, V_{GS} = 0$		-	0.76	1.1	V

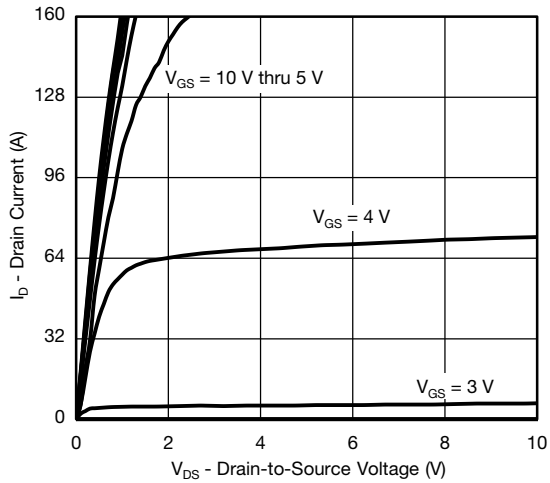
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.
 c. Independent of operating temperature.

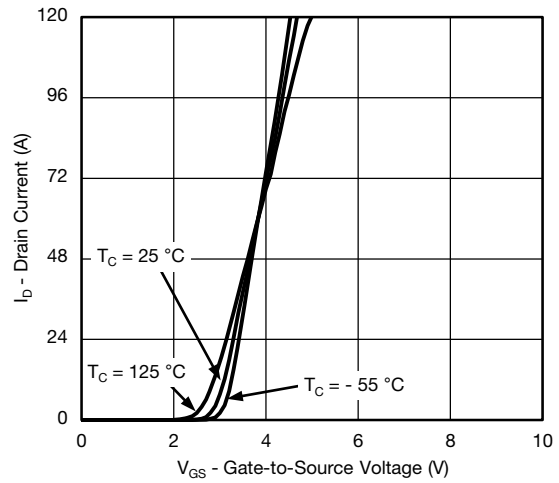
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



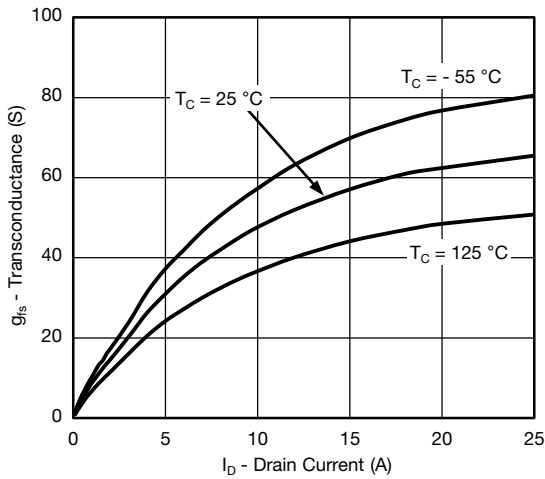
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



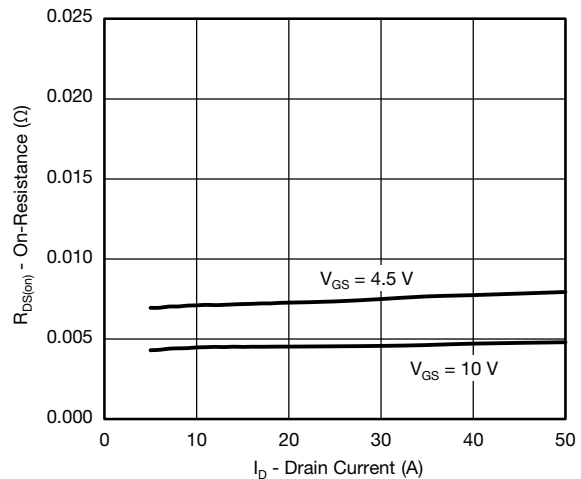
Output Characteristics



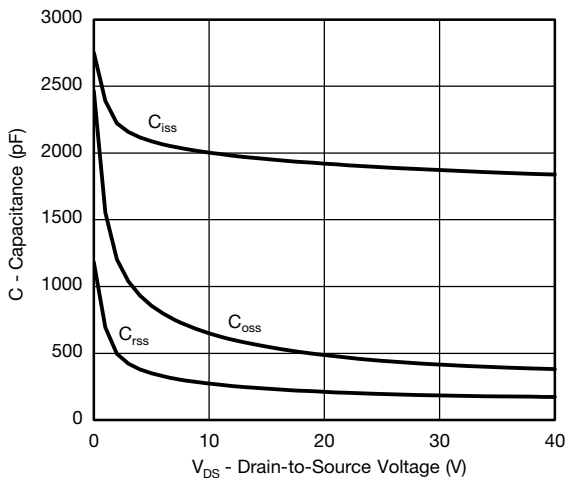
Transfer Characteristics



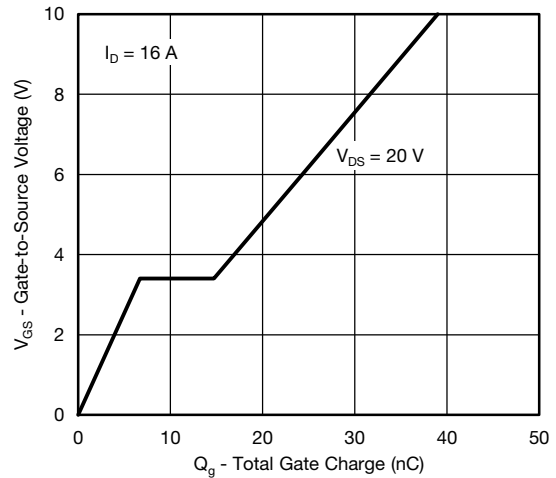
Transconductance



On-Resistance vs. Drain Current



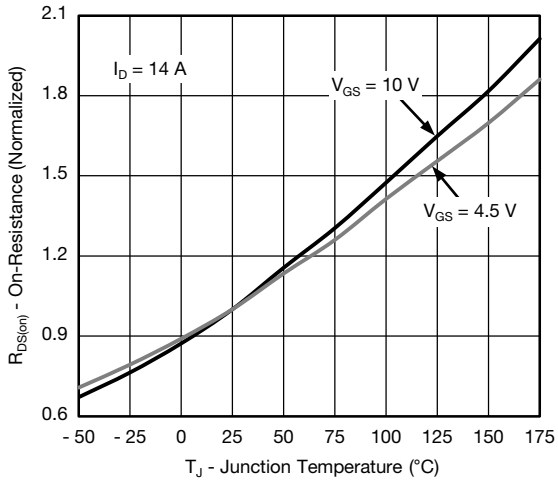
Capacitance



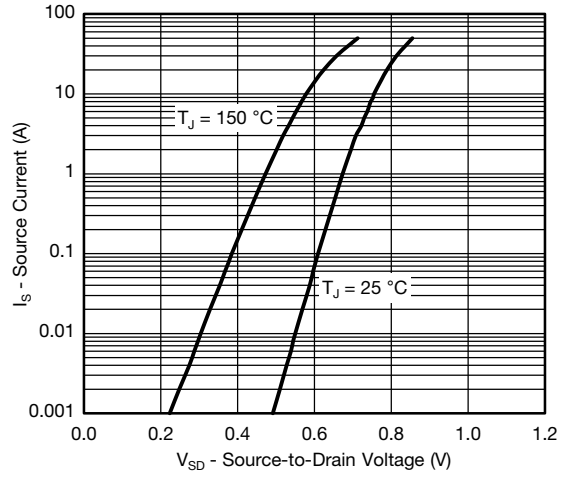
Gate Charge



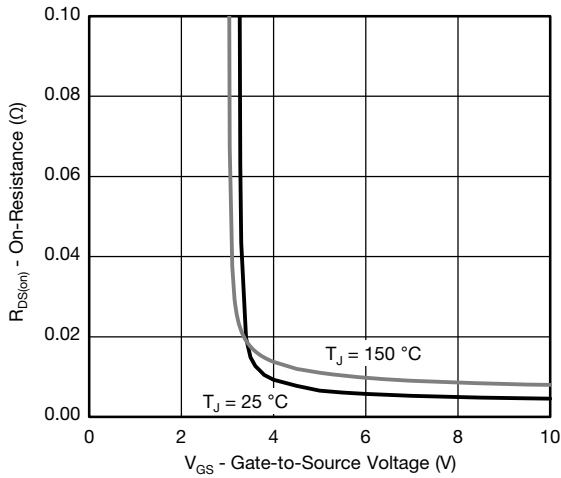
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



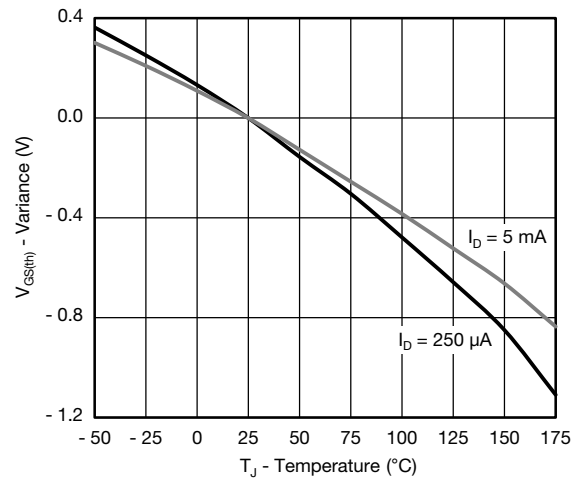
On-Resistance vs. Junction Temperature



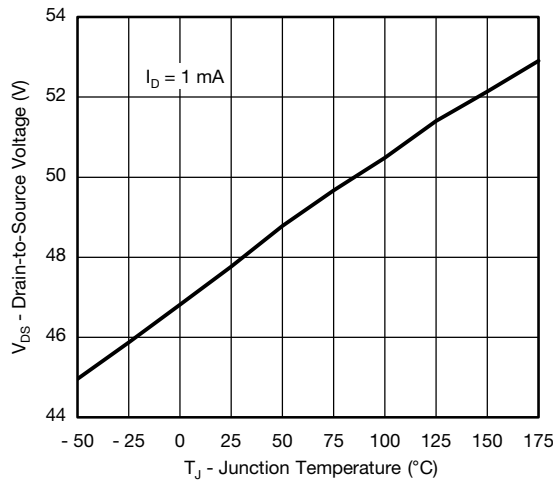
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



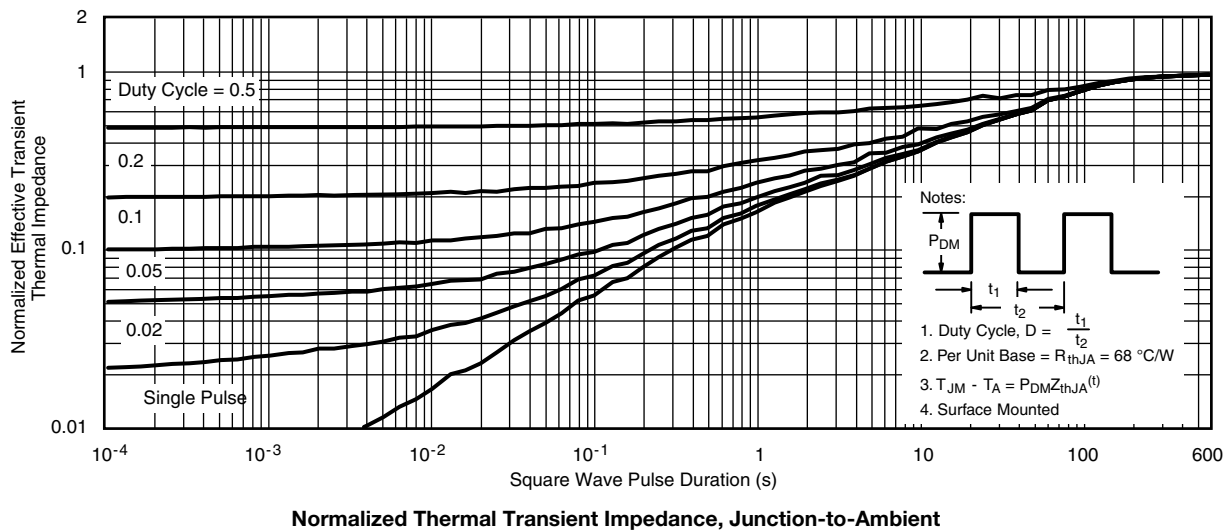
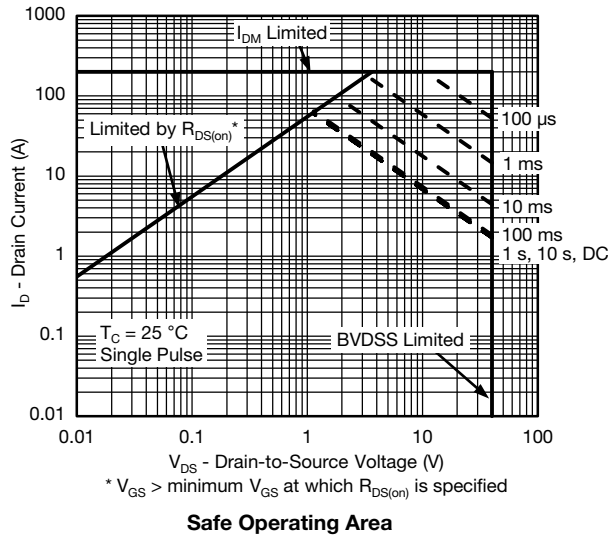
Threshold Voltage

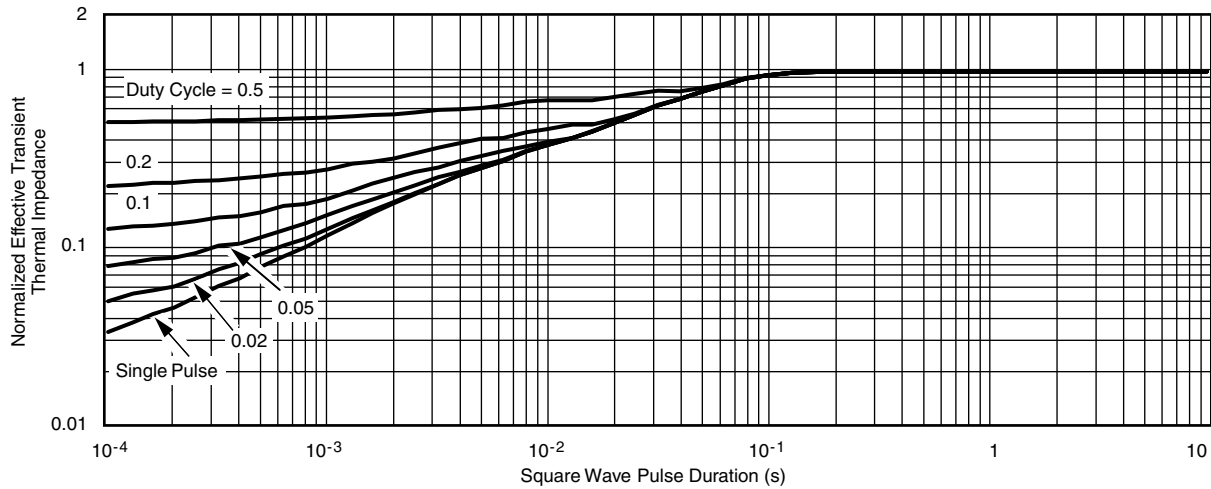


Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)




THERMAL RATINGS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Case
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient ($25\text{ }^\circ\text{C}$)
 - Normalized Transient Thermal Impedance Junction-to-Case ($25\text{ }^\circ\text{C}$)
 are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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